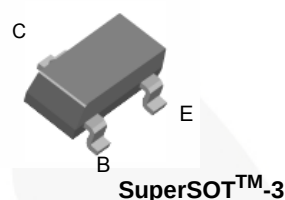


FSB749

PNP Low Saturation Transistor

Description

These devices are designed with high-current gain and low saturation voltage with collector currents up to 3 A continuous. Sourced from process PC.



Ordering Information

Part Number	Top Mark	Package	Packing Method
FSB749	749	SSOT 3L	Tape and Reel

Absolute Maximum Ratings^{(1),(2)}

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Value	Unit
V_{CEO}	Collector-Emitter Voltage	-25	V
V_{CBO}	Collector-Base Voltage	-35	V
V_{EBO}	Emitter-Base Voltage	-5	V
I_C	Collector Current - Continuous	-3	A
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to +150	$^\circ\text{C}$

Notes:

1. These ratings are based on a maximum junction temperature of 150°C .
2. These are steady-state limits. Fairchild Semiconductor should be consulted on applications involving pulsed or low-duty cycle operations.

Thermal Characteristics⁽³⁾

Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Max.	Unit
P_D	Total Device Dissipation	500	mW
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	250	$^\circ\text{C/W}$

Note:

3. PCB size: FR-4 76 x 114 x 1.57 mm³ (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.

Electrical Characteristics⁽⁴⁾

Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

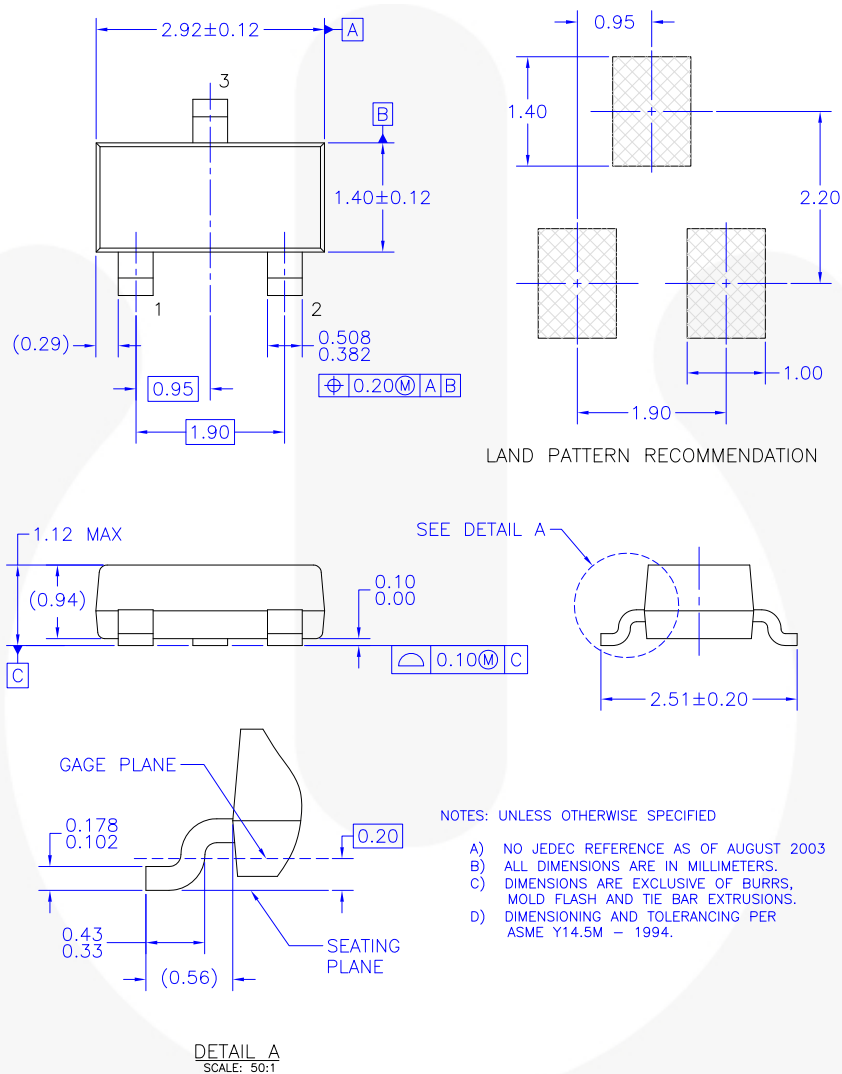
Symbol	Parameter	Conditions	Min.	Max.	Unit
BV_{CEO}	Collector-Emitter Breakdown Voltage	$I_C = -10\text{ mA}$	-25		V
BV_{CBO}	Collector-Base Breakdown Voltage	$I_C = -100\text{ }\mu\text{A}$	-35		V
BV_{EBO}	Emitter-Base Breakdown Voltage	$I_E = -100\text{ }\mu\text{A}$	-5.0		V
I_{CBO}	Collector Cut-Off Current	$V_{CB} = -30\text{ V}$		-100	nA
		$V_{CB} = -30\text{ V}, T_A = 100^\circ\text{C}$		-10	μA
I_{EBO}	Emitter Cut-Off Current	$V_{EB} = -4\text{ V}$		-100	nA
h_{FE}	DC Current Gain	$I_C = -50\text{ mA}, V_{CE} = -2\text{ V}$	70		
		$I_C = -1.0\text{ A}, V_{CE} = -2\text{ V}$	100	300	
		$I_C = -2.0\text{ A}, V_{CE} = -2\text{ V}$	75		
		$I_C = -6.0\text{ A}, V_{CE} = -2\text{ V}$	15		
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = -1\text{ A}, I_B = -100\text{ mA}$		-300	mV
		$I_C = -3\text{ A}, I_B = -300\text{ mA}$		-600	
$V_{BE(sat)}$	Base-Emitter Saturation Voltage	$I_C = -1\text{ A}, I_B = -100\text{ mA}$		-1.25	V
$V_{BE(on)}$	Base-Emitter On Voltage	$I_C = -1\text{ A}, V_{CE} = -2\text{ V}$		-1	V
C_{ob}	Output Capacitance	$V_{CB} = -10\text{ V}, I_E = 0,$ $f = 1\text{ MHz}$		100	pF
f_T	Current Gain - Bandwidth Product	$I_C = -100\text{ mA}, V_{CE} = -5\text{ V},$ $f = 100\text{ MHz}$	100		MHz

Note:

4. Pulse test: pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2.0\%$.

Physical Dimensions

SSOT 3L



MA03BREV B

Figure 1. MOLDED PACKAGE, SUPERSOT, 3-LEAD (ACTIVE)

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

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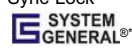
<http://www.fairchildsemi.com/dwg/MA/MA03B.pdf>.

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FastvCore™	OPTOLOGIC®	SuperSOT™-8	VoltagePlus™
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No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
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